



# Ai-M62-M2-I Specification

- Version V1.0.1
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# **Document resume**

Version	Date	Develop/revise content	Edition	Approve
V1.0.0	2023.03.21	First Edition	Chaomei Deng	Ning Guan
V1.0.1	2023.11.17	<ol> <li>Update the chip block diagram and the supported peripheral interfaces;</li> <li>Add important statements</li> </ol>	Ning Guan	Hong Xu



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# **1. Product Overview**

Ai-M62-M2-I is a Wi-Fi 6 + BLE5.3 module developed by Shenzhen Ai-Thinker Technology Co., Ltd. The module is equipped with BL616 chip as the core processor, supports Wi-Fi 802.11b/g/n/ax protocol and BLE protocol, and supports Thread protocol. The BL616 system includes a low-power 32-bit RISC-V CPU with floating-point unit, DSP unit, cache and memory, with a maximum dominant frequency of 320M.

The Ai-M62-M2-I module has rich peripheral interfaces, including USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP and GPIO, etc. It can be widely used in audio and video multimedia, Internet of Things (IoT), mobile devices, wearable electronic devices, smart homes and other fields.

The Ai-M62-M2-I module Sec Eng module supports AES/SHA/PKA/TRNG and other functions, supports image encryption and signature startup, and meets various security application requirements in the Internet of Things field.

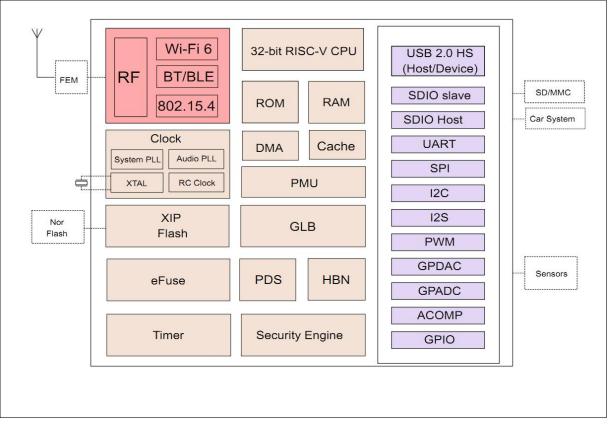


Figure 1 Main chip architecture diagram



### **1.1.** Characteristics

- SMD-30 package
- Supports 2.4GHz operating frequency band
- Support IEEE 802.11 B/g/n/ax
- Support BLE5.3
- Support Thread
- Support Wi-Fi/BLE/Thread coexistence
- Wi-Fi security support WPS/WEP/WPA/WPA2/WPA3
- Supports 20/40MHz bandwidth, 1T1R, maximum rate 229.4 Mbps
- Support STA, SoftAP, STA + SoftAP and sniffer modes
- 32-bit RISC-V CPU with FPU and DSP, with a maximum dominant frequency of 320M
- 532KB SRAM,128KB ROM,4Kb eFuse
- Support for USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP and GPIO, etc.
- Integrated RF Balun, PA/LNA
- Support for safe startup and safe debugging
- Support XIP QSPI On-The-Fly AES decryption (OTFAD)
- Support TrustZone
- Support AES-CBC/CCM/GCM/XTS mode
- Support MD5, SHA-1/224/256/384/512
- TRNG (True Random Number Generator) is supported
- Support PKA (Public Key Accelerator) for RSA/ECC
- BLE-enabled Wi-Fi fast connection
- Universal AT command can be used quickly.
- Supports secondary development and integrates Windows and Linux development environments



# 2. Main parameters

Model	Ai-M62-M2-I	
Package	SMD-30	
Size	$13.2*13.6*3.0(\pm 0.2)$ mm	
Antenna	IPEX connector	
Frequency	2400 ~ 2483.5MHz	
Operating temperature	-40°C ~ 85°C	
Storage temperature	-40°C ~ 125°C, < 90%RH	
<b>Power supply</b>	Support voltage 2.97V ~ 3.6V, supply current $\geq$ 500mA	
Interface	USB2.0, SDU, SD / MMC (SDH), SPI, UART, I2C, I2S, PWM, GPDAC, GPADC, ACOMP, GPIO and so on	
ΙΟ	18	
UART rate         Default 115200 bps		
Security	WPS/WEP/WPA/WPA2/WPA3	
Flash	Default 4MByte	

#### Table 1 Description of the main parameters

### 2.1. Static electricity requirement

Ai-M62-M2-I is an electrostatic sensitive device. Therefore, you need to take special precautions when carrying it.





### 2.2. Electrical characteristics

Parameters		Conditio	Min.	Typical value	Max.	Unit
Supply voltage		VDD	2.97	3.3	3.6	V
	VIL	-	-	-	0.3*VDDIO	V
	VIH	-	0.7*VDDIO	-	-	V
I/O	VOL	-	-	0.1*VDDIO	-	V
	VOH	-	-	0.9*VDDIO	-	V
	IMAX	-	-	-	15	mA

# 2.3. Wi-Fi RF Performance

#### Table 3 Wi-Fi RF performance table

Description	Typical value			Unit
Frequency range	2400 ~ 2483.5MHz			MHz
	Output I	Power		
Mode	Min.	Typical value	Max.	Unit
11ax mode HE40,PA output power	-	16	-	dBm
11ax mode HE20,PA output power	-	17	-	dBm
11n mode HT40,PA output power	-	19	-	dBm
11n mode HT20,PA output power	-	19	-	dBm
11g mode, PA output power	-	19	-	dBm
11b mode, PA output power	-	22	-	dBm
Output Power				
Mode	Min.	Typical value	Max.	Unit
11b, 1 Mbps	-	-98	-	dBm
11b, 11 Mbps	-	-90	-	dBm
11g, 6 Mbps	-	-93	-	dBm
11g, 54 Mbps	-	-76	-	dBm
11n, HT20 (MCS7)	-	-73	-	dBm
11ax, HE20 (MCS9)	-	-70	-	dBm
11ax, HE40 (MCS9)	-	-67	-	dBm

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# 2.4. BLE RF Performance

Description		Unit				
Frequency range	ency range 2400			MHz		
	Output Power					
Rate Mode	Min.	Typical value	Max.	Unit		
1Mbps	-	10	15	dBm		
2Mbps	-	10	15	dBm		
Receive Sensitivity						
Rate Mode	Min.	Typical value	Max.	Unit		
1Mbps sensitivity@30.8%PER	-	-99	-	dBm		
2Mbps sensitivity@30.8%PER	-	-97	-	dBm		

#### Table 4 BLE RF performance table

#### 2.5. Power

The following power consumption data are based on a 3.3V power supply, 25°C ambient temperature, and measured using an internal voltage regulator.

- All measurements are made at the antenna interface with a filter.
- All transmission data are based on 100% duty cycle in continuous transmission mode.

#### **Table 5 Power consumption**

Mode	Min.	AVG	Max.	Unit
Tx 802.11b, 11Mbps, POUT=+22dBm	-	415	-	mA
Tx 802.11g, 54Mbps, POUT =+19dBm	-	298	-	mA
Tx 802.11n, MCS7, POUT =+19dBm	-	300	-	mA
Tx 802.11ax, MCS9, POUT =+17dBm	-	280	_	mA
Rx 802.11b,packet length 1024 byte	-	59	-	mA
Rx 802.11g,packet length 1024 byte	-	59	-	mA
Rx 802.11n,Packet length 1024 byte	-	59	_	mA
Rx 802.11b,packet length 1024 byte	-	59	-	mA



# 3. Appearance Dimensions

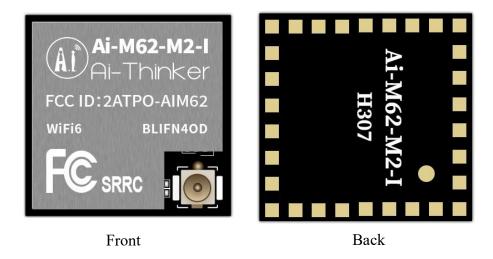
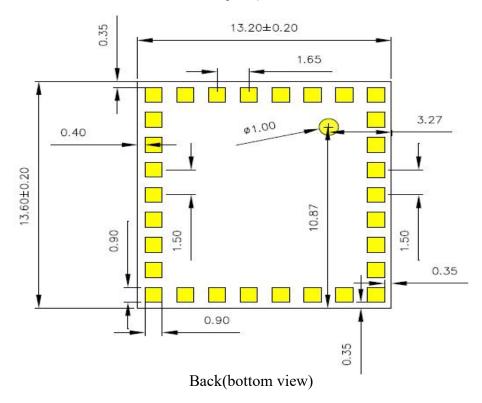
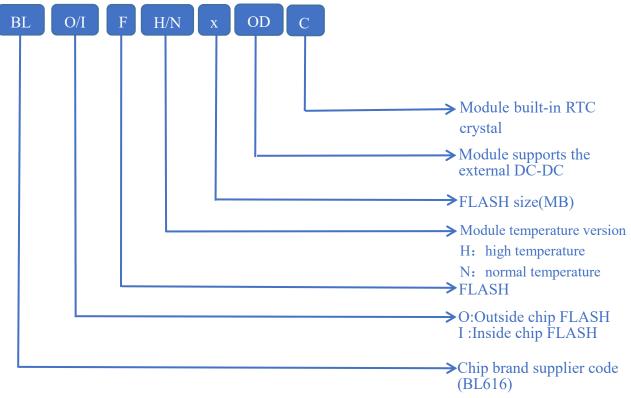


Figure 3 Appearance diagram (Rendering figure is for reference only, subject to physical objects)



**Figure 4 Dimension diagram** 

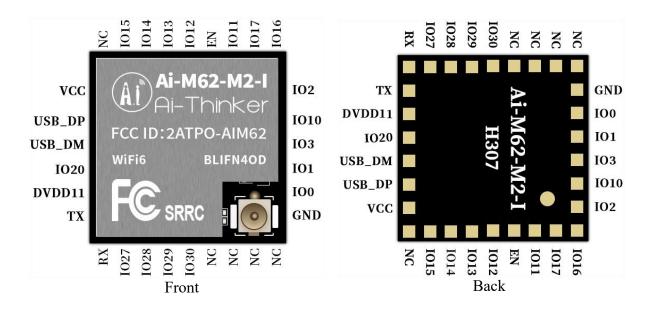




**Figure 5 Shield printing information** 

# 4. Pin Definition

Ai-M62-M2-I module is connected with a total of 30 pins, as shown in the pin schematic diagram, pin function definition table is the interface definition.



#### Figure 6 Schematic diagram of module pins



### Table 6 Pin function definition table

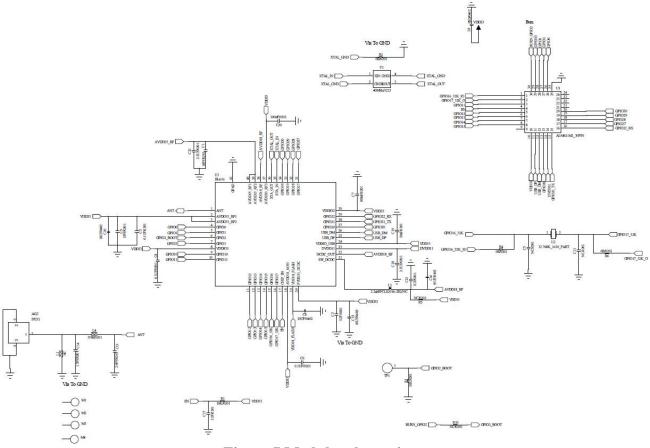
No.	Name	Function
1	IO16	Available by default, the IO port is shared with the PIN pin of the 32.768KHz crystal oscillator input inside the module. If the module of the internal patch 32.768KHz crystal oscillator is customized, the IO is in NC state. GPIO16/SPI_SS/I2S_BCLK/I2C_SCL/XTAL_32K_IN/PWM0
2	IO17	Available by default, the IO port is shared with the 32.768KHz crystal output PIN pin inside the module. If the module of the internal patch 32.768KHz crystal oscillator is customized, the IO is in NC state. GPIO17/SPI_SCLK/I2S_FS/I2C_SDA/XTAL_32K_OUT/PWM0
3	IO11	GPIO11/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/PWM0
4	EN	Default as chip enable, high level valid
5	IO12	GPIO12/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH6/PWM0
6	IO13	GPIO13/SPI_SCLK/I2S_FS/I2C_SDA/ADC_CH5/PWM0
7	IO14	GPIO14/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/ADC_CH4/PW M0
8	IO15	GPIO15/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/PWM0
10	VCC	3.3V power supply; The output current of external power supply is
11	USB_DP	USB_DP
12	USB_DM	USB_DM
13	IO20	GPIO20/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH0/PWM0
14	DVDD11	DVDD11 power supply; Ultra-low power consumption usage scenarios require external power supply of 1.1V; Non-ultra-low power consumption usage scenarios, suspended processing
15	TX	TXD/GPIO21/SPI_SCLK/I2S_FS/I2C_SDA/ADC_RCAL_VOUT/P WM0
16	RX	RXD/GPIO22/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/PWM0
17	IO27	GPIO27/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/ADC_CH10/P WM0
18	IO28	GPIO28/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH11/PWM0
19	IO29	GPIO29/SPI_SCLK/I2S_FS/I2C_SDA/PWM0
20	IO30	GPIO30/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/PWM0
25	GND	GND
26	IO0	GPIO0/SPI_SS/I2S_BCLK/I2C_SCL/ADC_CH9/PWM0
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27	IO1	GPIO1/SPI_SCLK/I2S_FS/I2C_SDA/ADC_CH8/PWM0
28	IO3	GPIO3/SPI_MOSI/I2S_DO/I2S_RCLK_O/I2C_SDA/ADC_CH3/PW M0
29	IO10	GPIO10/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/ADC_CH7/PW M0
30	IO2	The default NC is not available. If you need to use it, please contact Anxin. If elicited, support Bootstrap/GPIO2/SPI_MISO/I2S_DI/I2S_RCLK_O/I2C_SCL/ADC_
9,21,22,23, 24	NC	NC
Note: 1. GPIO2 is used as a Bootstrap. When the power-on moment is high, the module enters the burning mode. When the power-on moment is low, the module starts normally.		



# 5. Schematic



**Figure 7 Module schematic** 



# 6. Design Guidance

### 6.1. Module application circuit

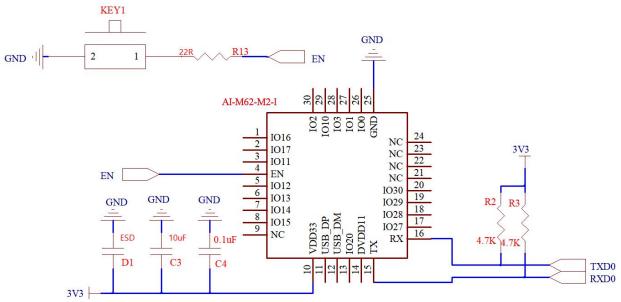


Figure 8 Application circuit diagram

- IO2 is the module start control pin, which is in normal working mode at low level and in firmware burning mode at high level. The default low level inside the module.
- IO2/NC, not available by default
- GPIO16/GPIO17, available by default. These IO ports are shared with the PIN pin of the 32.768KHz crystal oscillator inside the module. If the module of the internal patch 32.768KHz crystal oscillator is customized, the IO is in NC state



### 6. 2. Recommend PCB footprint size

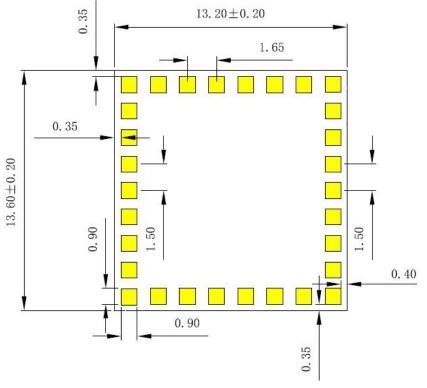


Figure 9 Recommend PCB footprint size

### 6.3. Antenna layout requirements

The following two methods are recommended for the installation position on the mainboard:

Option 1: put the module on the edge of the motherboard, and the antenna area extends out of the edge of the motherboard.

• Option 2: put the module on the edge of the motherboard, the edge of the motherboard at the antenna position hollowed out an area.



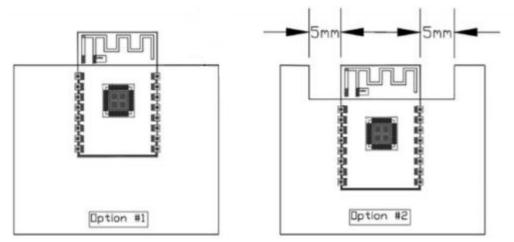


Figure 10 Antenna layout diagram

### 6.4. Power supply

- Recommended 3.3V voltage, peak current over 500mA.
- Power supply is recommend to use LDO; if the DC-DC is used, the ripple is recommended to be controlled within 30mV
- DC-DC power supply circuit proposes to reserve the dynamic response capacitance to optimize the output ripple with large load changes.
- It is recommended to add ESD devices to the 3.3V power interface.

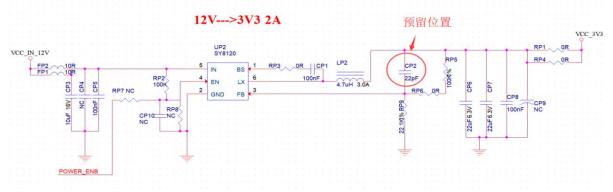


Figure 11 DC-DC step-down circuit diagram



### 6.5. GPIO

- There are some IO ports on the periphery of the module. If you need to use it, it is recommended to connect a 10-100 ohm resistor in series with the IO port. This inhibits overshoot and makes both sides level more stable. It is helpful for EMI and ESD.
- For special I/O ports to be pulled up and down, refer to the usage instructions in the specifications, which may affect the module startup configuration.
- The IO port of the module is 3.3V. If the IO level of the main control and the module do not match, a level conversion circuit needs to be added.
- If the I/O port is directly connected to a peripheral port or terminals, for example, a pin row, reserve an ESD device near the terminal of the I/O cable.

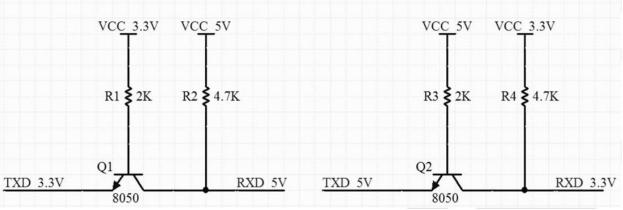


Figure 12 Level convert circuit



# 7. Storage conditions

Products sealed in moisture-proof bags should be stored in a non-condensing atmosphere of  $<40 \circ C /90\%$ RH.

The module has a moisture sensitivity rating of MSL 3.

After the vacuum bag is opened, it must be used within 168 hours at 25±5°C/60%RH, otherwise it needs to be baked before it can be put on line again.

#### (0°) 道 通 峰值温度 235 ~ 250°C 250 回流区 预热恒温区 冷却区 -1 ~ -5°C/s 150 ~ 200°C 60 ~ 120s >217°C 60~90s 217 200 焊接时间 > 30s 升温区 ~ 3°C/s 100 50 25 时间 (s) 0 100 150 200 250 50 0 升温区 - 温度: 25~150°C 时间: 60~90s 升温斜率: 1~3°C/s 预热恒温区 - 温度: 150~200°C 时间: 60~120s 回流焊接区 - 温度: >217°C 时间: 60~90s; 峰值温度: 235~250°C 时间: 30~70s 冷却区 — 温度: 峰值温度~180°C 降温斜率-1~-5°C/s 焊料 - 锡银铜合金无铅焊料 (SAC305)

# 8. Reflow welding curve diagram

Figure 13 Reflow welding diagram



# 9. Product Packaging Information

Ai-M62-M2-I module was packaged in a tape, 900pcs/reel.As shown in the below image:



#### Figure 14 Package and packing diagram

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Taobao shop

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WeChat mini program



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